

**Silicon Carbide Power MOSFET 650V N-Channel MOS****■ Applications**

- Switch Mode Power Supplies
- High Voltage DC/DC Converters
- Battery Chargers
- Motor Drives
- Pulsed Power applications

■ Features

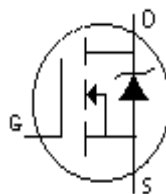
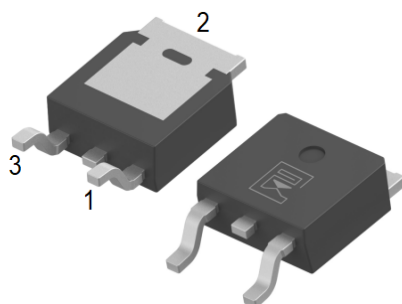
- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitances
- Easy to Parallel and Simple to Drive
- Avalanche Ruggedness
- Halogen Free, RoHS Compliant

■ Product Summary

V_{DS}	650	V
I_D	12	A
$R_{DS(ON)}$, Typ@18V	300	m Ω
Q_g	21	nC

■ Benefits

- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency



Gate: 1
Drain: 2
Source: 3

TO-252

Marking	Package	Packaging	Min. package quantity
MK3C300R065	TO-252	Tape & Reel	3000





■ Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	650	V
Gate-Source Voltage	V_{GS}	- 10/+22	V
Recommended operational values	V_{GSop}	0/+18	V
Continuous Drain Current Tc=25°C V_{GS} =18V (Note 1)	I_D	12	A
Continuous Drain Current Tc=100°C V_{GS} =18V (Note 1)		9	A
Drain Current-Pulsed (Note 1)	I_{DM}	24	A
Total Dissipation	P_D	60	W
Junction Temperature	T_j	175	°C
Storage Temperature	T_{stg}	- 55~175	°C
Single Pulse Avalanche Energy (Note 2)	E_{AS}	20	mJ

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

■ Thermal Characteristics

Parameter	Symbol	Max	Unit
Maximum Junction-to-Case	$R_{\theta JC}$	2.5	°C/W
Maximum Junction-to-Ambient	$R_{\theta JA}$	60	°C/W

Note 1: Ensure that the channel temperature does not exceed 175°C.

Note 2: VDD=100V, Tch= 25°C(initial), L=0.5mH

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.





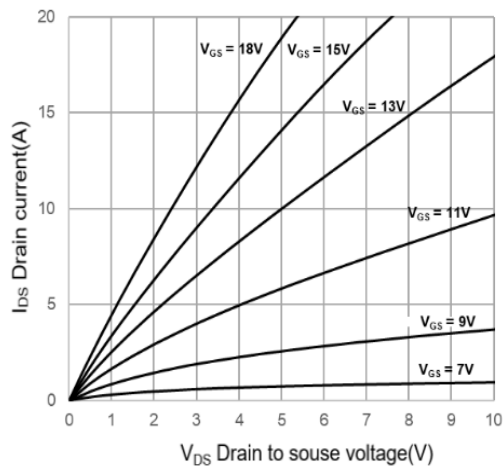
■ Electrical Characteristics (Tc=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static Parameters						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=500\mu A$	650	-	-	V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=650V, V_{GS}=0V$	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=18V, V_{DS}=0V$	-	-	100	nA
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS}=V_{DS}, I_{DS}=5mA$	3.0	4	5.0	V
Drain-Source On Resistance	$R_{DS(ON)}$	$V_{GS}=15V, I_D=6A$	-	380	460	mR
		$T_J=175^{\circ}C$	-	360	-	
		$V_{GS}=18V, I_D=6A$	-	300	360	
		$T_J=175^{\circ}C$	-	340	-	
Transconductance	g_{fs}	$V_{GS}=20V, I_D=6A$	-	1.1		S
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$	-	266	-	pF
Output Capacitance	C_{oss}		-	69	-	pF
Reverse Transfer Capacitance	C_{rss}		-	5	-	pF
Gate Resistance	R_g	$V_{DS}=0V, V_{GS}=0V, f=1.0MHz$	-	4.4	-	Ω
Switching Paramters						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=500V, V_{GS}=0/15V, I_D=5A, R_{G(ext)}=10\Omega$	-	26	-	ns
Turn-On Rise Time	t_r		-	41	-	ns
Turn-Off Delay Time	$t_{d(off)}$		-	27	-	ns
Turn-Off Fall Time	t_f		-	71	-	ns
Turn-On Switching Energy	E_{ON}		-	38	-	μJ
Turn-Off Switching Energy	E_{OFF}		-	5.2	-	
Total Gate Charge	Q_g	$V_{DD}=500V, V_{GS}=0/15V, I_D=8.5A$	-	21	-	nC
Gate-Source Charge	Q_{gs}		-	7	-	nC
Gate-Drain Charge	Q_{gd}		-	12	-	nC
Source-Drain Characteristics						
Diode Forward Voltage	V_{sd}	$V_{GS}=0V, I_{SD}=3A,$	-	3.5	-	V
Continuous Diode Forward Current	I_S	$T_C=25^{\circ}C$	-	12	-	A
Reverse Recovery Time	t_{rr}	$VR=400V, IF=10A, di/dt=100A/us$	-	21	-	ns
Reverse Recovery Charge	Q_{rr}		-	16	-	nC
Peak Reverse Recovey Current	I_{mm}		-	1.5	-	A

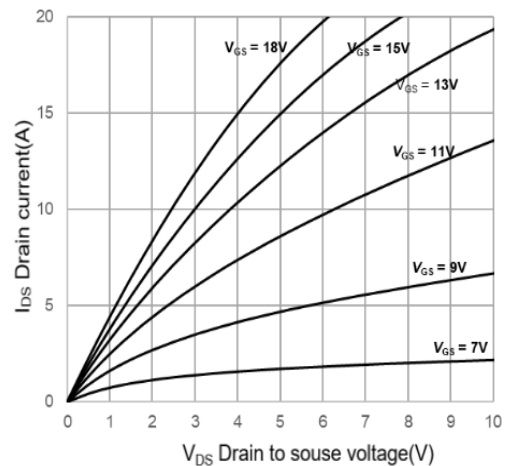




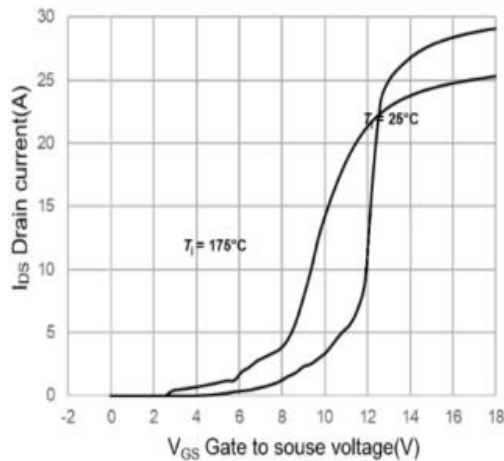
■ Characteristics Curves



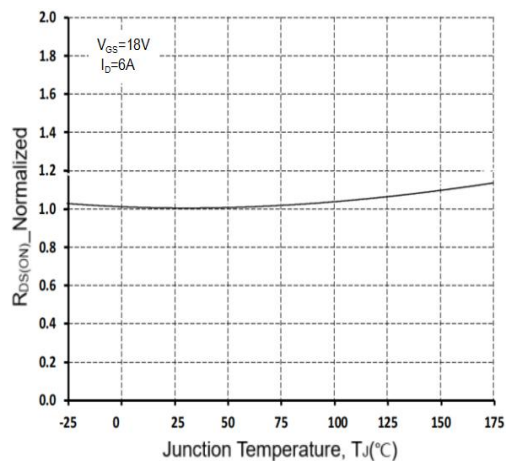
Output Characteristics $T_J = 25^\circ\text{C}$



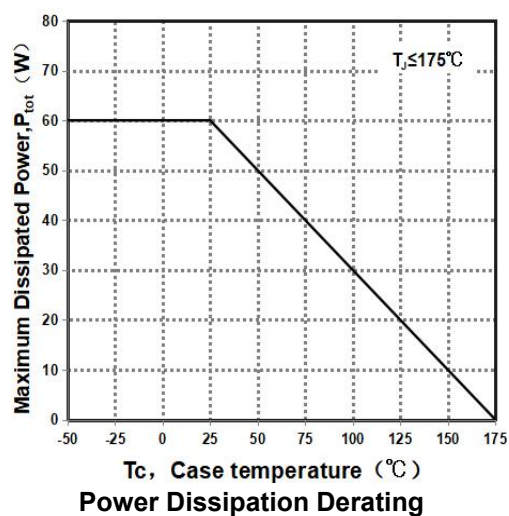
Output Characteristics $T_J = 175^\circ\text{C}$



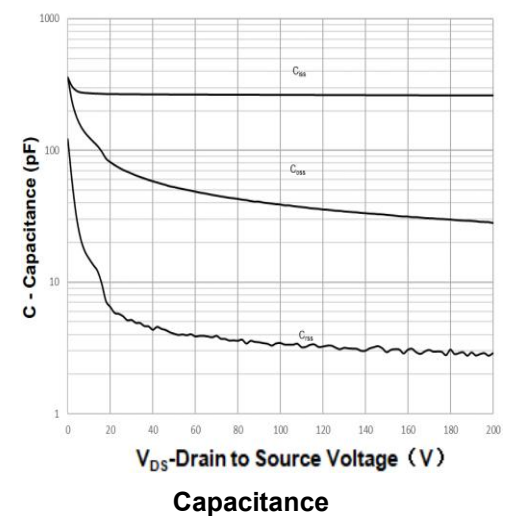
Transfer Characteristics



Normalized On-Resistance vs. Temperature

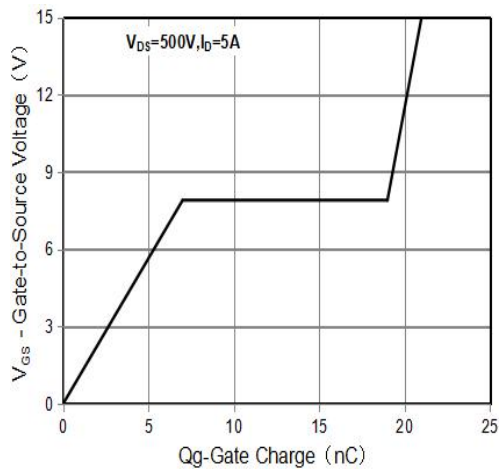


Power Dissipation Derating

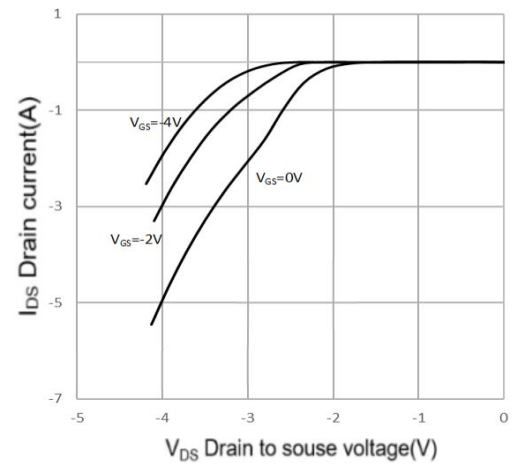


Capacitance

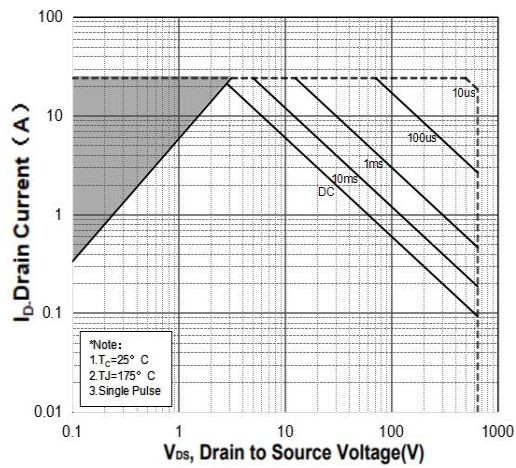




Gate Charge Waveform



Source-Drain Diode Characteristics, $T_J=25^{\circ}\text{C}$



Safe Operating Area

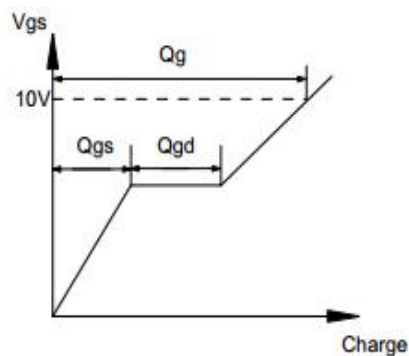
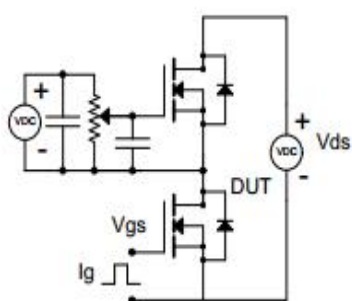
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



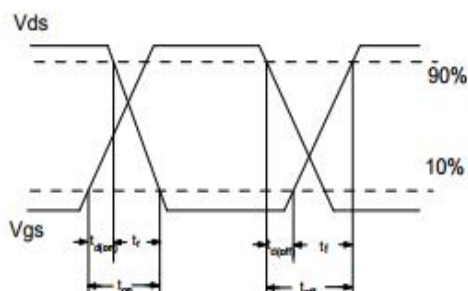
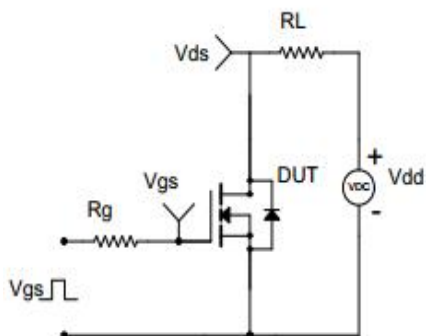


■ Test Circuit & Waveform

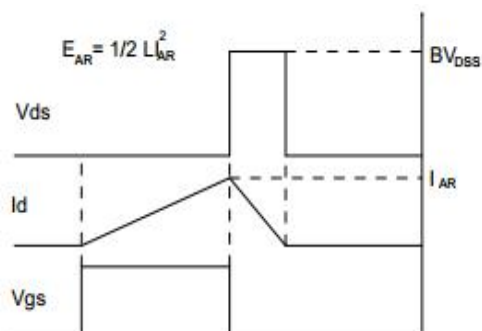
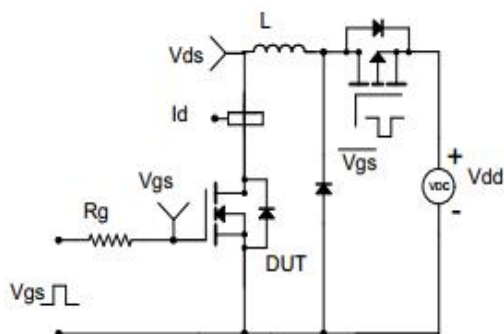
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



Unclamped Inductive Switching (UIS) Test Circuit & Waveform





■ TO-252 Package Dimensions

Unit: mm

Symbol	Min	Nom	Max	Symbol	Min	Nom	Max
A	2.20		2.40	L	9.80		10.40
A1	0.00		0.13	L1		2.90	
b	0.66		0.86	L2	1.40		1.60
c	0.46		0.58	L3		1.80	
D	6.50		6.70	L4	0.60		1.00
D1	5.10		5.46	L5	0.90		1.25
D2		4.83		Φ	1.1		1.30
E	6.00		6.20	θ	0°		8°
e	2.19		2.39	V		5.35	

